

FEATURES

- Four Quadrant Multiplication
- 16-Bit Monotonicity
- Low Power Consumption
- TTL/5 V CMOS Compatible
- Single-Buffered or Transparent Data inputs
- Decoded DAC Approach
- Latch-Up Free
- 8-Bit Bus Version: MP7636A

APPLICATIONS

- Digitally Programmable References
- Programmable Audio Attenuator
- High Accuracy Process Control Systems
- Automatic Test Equipment
- Easy Interface to 8 and 16-Bit Microprocessor Buses

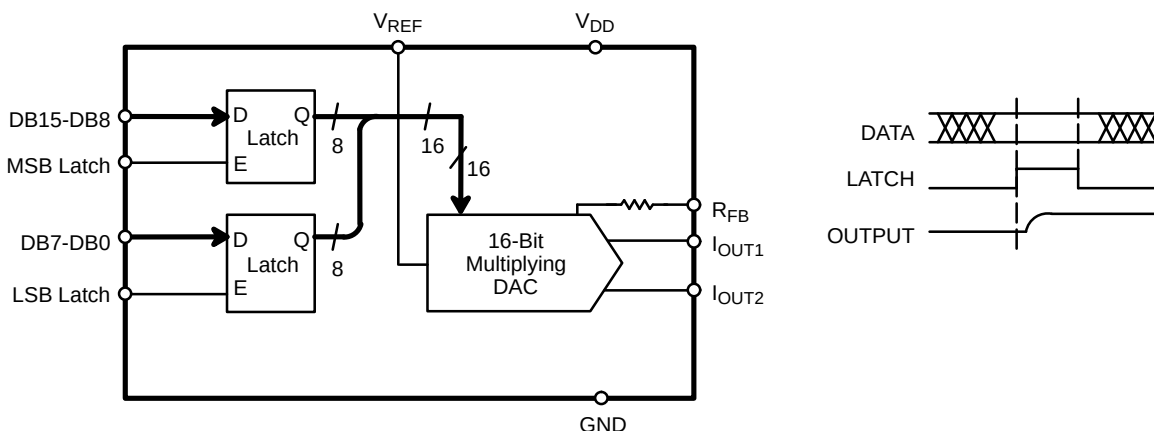
GENERAL DESCRIPTION

The MP7626 is a CMOS 16-bit Digital-to-Analog Converter (DAC) that is manufactured using advanced thin film resistors on a double metal CMOS process. It incorporates a unique bit decoding technique yielding lower glitch, higher speed and

excellent accuracy over temperature and time. 16 bit differential non-linearity is achieved with minimal trimming.

Two 8-bit latches (MSB latch and LSB latch) hold the 16-bit data which are converted by the DAC. A 16-bit bus can load both latches in one cycle. An 8-bit bus loads one latch at a time. By making the latches transparent (MSB latch = LSB latch = High) the DAC will continuously convert the BIT1 - BIT16 inputs.

SIMPLIFIED BLOCK AND TIMING DIAGRAM



ELECTRICAL CHARACTERISTICS

(VDD = + 15 V, VREF = +10 V unless otherwise noted)

Parameter	Symbol	25°C			Tmin to Tmax		Units	Test Conditions/Comments
Min	Typ	Max	Min	Max				
STATIC PERFORMANCE ¹								
Resolution (All Grades)	N	16			16		Bits	FSR = Full Scale Range Best Fit Straight Line Spec. (Max INL – Min INL) / 2 Using Internal R _{FB} ΔGain/ΔTemperature ΔGain/ΔV _{DD} ΔV _{DD} = ± 5% I _{OUT1}
Relative Accuracy	INL						LSB	
J				±4		±4		
K				±2		±2		
Differential Non-Linearity	DNL						LSB	
J				±4		±4		
K				±2		±2		
Gain Error	GE			±0.1		±0.1	% FSR	
Gain Temperature Coefficient ²	TC _{GE}					±2	ppm/°C	
Power Supply Rejection Ratio	PSRR			±50		±50	ppm/%	
Output Leakage Current	I _{OUT}			±10		±200	nA	
DYNAMIC PERFORMANCE ²								
Current Settling Time	t _S		2				μs	Full Scale Change to 0.1% V _{REF} = 10kHz, 20 Vp-p, sinewave
AC Feedthrough at I _{OUT1}	F _T		2				mV p-p	
REFERENCE INPUT								
Input Resistance	R _{IN}	2.5		7.5	2.5	7.5	kΩ	
DIGITAL INPUTS ³								
Logical “1” Voltage	V _{IH}	3.0	2.4		3.0		V	
Logical “0” Voltage	V _{IL}			0.8		0.8	V	
Input Leakage Current	I _{LKG}			±1		±1	μA	
Input Capacitance ²								
Data	C _{IN}		5				pF	
Control	C _{IN}		5				pF	
ANALOG OUTPUTS ²								
Output Capacitance								DAC Inputs all 1's DAC Inputs all 0's DAC Inputs all 1's DAC Inputs all 0's
	C _{OUT1}			280			pF	
	C _{OUT1}			120			pF	
	C _{OUT2}			100			pF	
	C _{OUT2}			240			pF	
POWER SUPPLY								
Functional Voltage Range ⁵	V _{DD}	4.5		16.5	5.0	16.5	V	All digital inputs = 0 V or all = 5 V
Supply Current	I _{DD}			1		1	mA	

ELECTRICAL CHARACTERISTICS (CON'T)

Parameter	Symbol	Min	25°C Typ	Max	Tmin to Tmax Min Max	Units	Test Conditions/Comments
SWITCHING CHARACTERISTICS^{2, 4}							
Data Valid to Write Set-Up Time	t_{DS}	250				ns	
Write Strobe Width	t_{SW}	125				ns	

NOTES:

- ¹ Full Scale Range (FSR) is 10V for unipolar mode.
- ² Guaranteed but not production tested.
- ³ Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur.
- ⁴ See timing diagram.
- ⁵ Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)^{1, 2}

Supply Voltage +17 V_{DC}
 Voltage at Any Digital Input GND –0.5 to V_{DD} +0.5 V
 DC Voltage Applied to I_{OUT1} or I_{OUT2} .. GND –0.5 to +17 V
 Voltage at V_{REF} R_{FB} Inputs ±25 V

Storage Temperature Range –65°C to 150°C
 Package Power Dissipation Rating to 75°C
 CDIP, PDIP, PLCC 1050mW
 Derates above 75°C 14mW/°C

NOTES:

- ¹ Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- ² Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. *All inputs have protection diodes* which will protect the device from short transients outside the supplies of less than 100mA for less than 100µs.

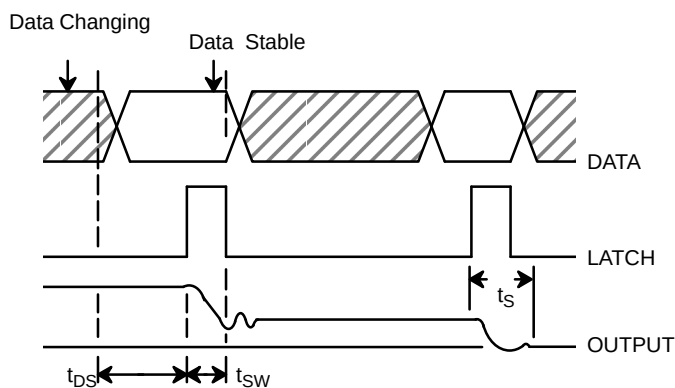
APPLICATION NOTES

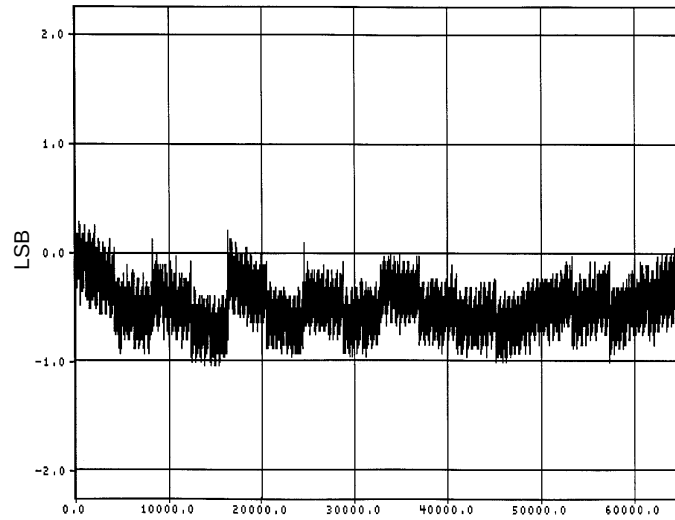
Refer to Applications Section for Additional Information

LATCH CONTROL

MSB LATCH	LSB LATCH	FUNCTION
0	0	Data Latched (Held)
1	0	Transfer (DB15-DB8) to DAC
0	1	Transfer (DB7-DB0) to DAC
1	1	Transparent Mode

TIMING DIAGRAM



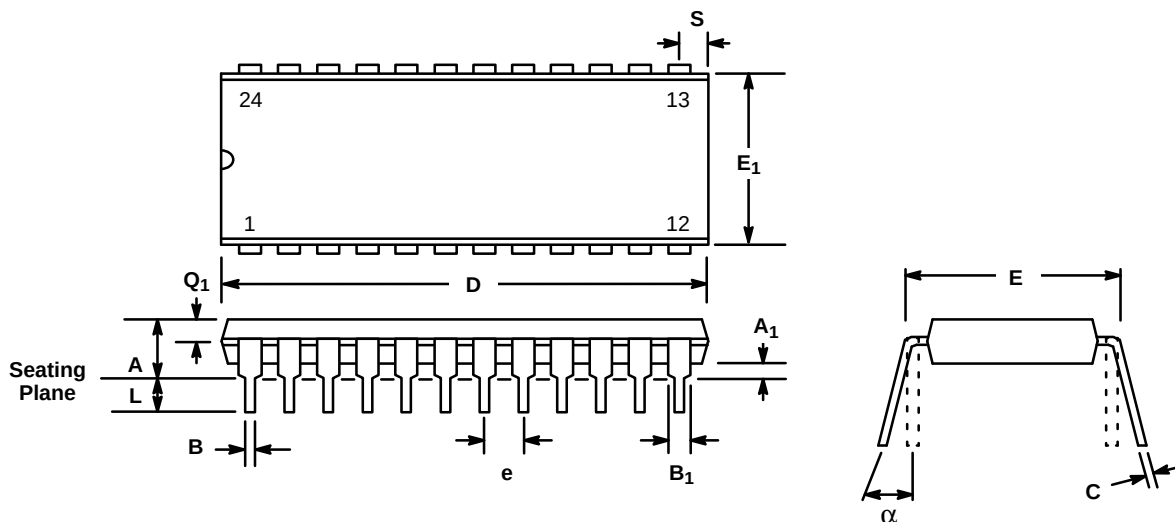


Graph 1. Relative Accuracy vs. Digital Code

APPLICATION NOTES

Refer to Section 8 for Applications Information

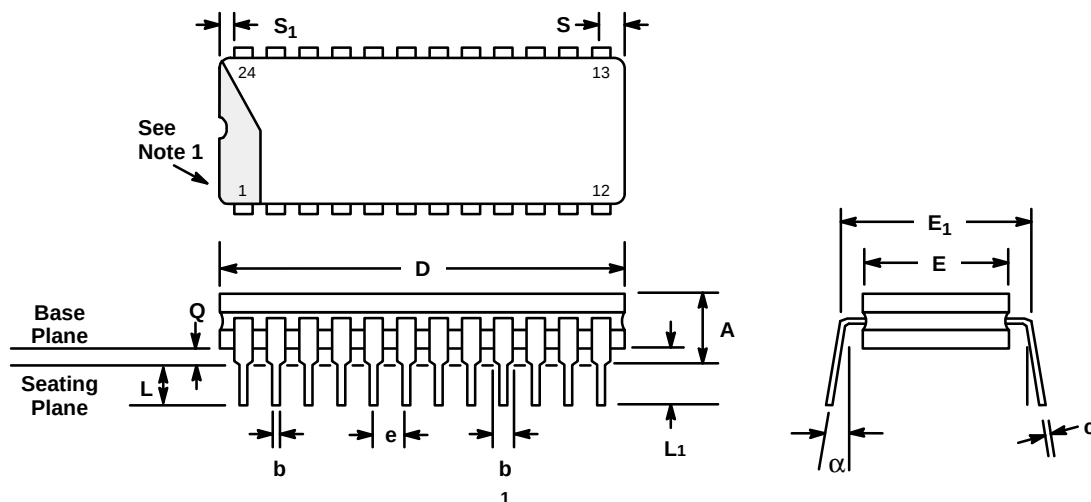
24 LEAD PLASTIC DUAL-IN-LINE
(600 MIL PDIP)
N24



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.225	—	5.72
A ₁	0.015	—	0.38	—
B	0.014	0.023	0.356	0.584
B ₁ (1)	0.038	0.065	0.965	1.65
C	0.008	0.015	0.203	0.381
D	1.160	1.290	29.46	32.77
E	0.585	0.625	14.86	15.88
E ₁	0.500	0.610	12.70	15.49
e	0.100 BSC		2.54 BSC	
L	0.115	0.150	2.92	3.81
α	0°	15°	0°	15°
Q ₁	0.055	0.070	1.40	1.78
S	0.040	0.098	1.02	2.49

Note: (1) The minimum limit for dimensions B1 may be 0.023" (0.58 mm) for all four corner leads only.

**24 LEAD CERAMIC DUAL-IN-LINE
(600 MIL CDIP)
D24**

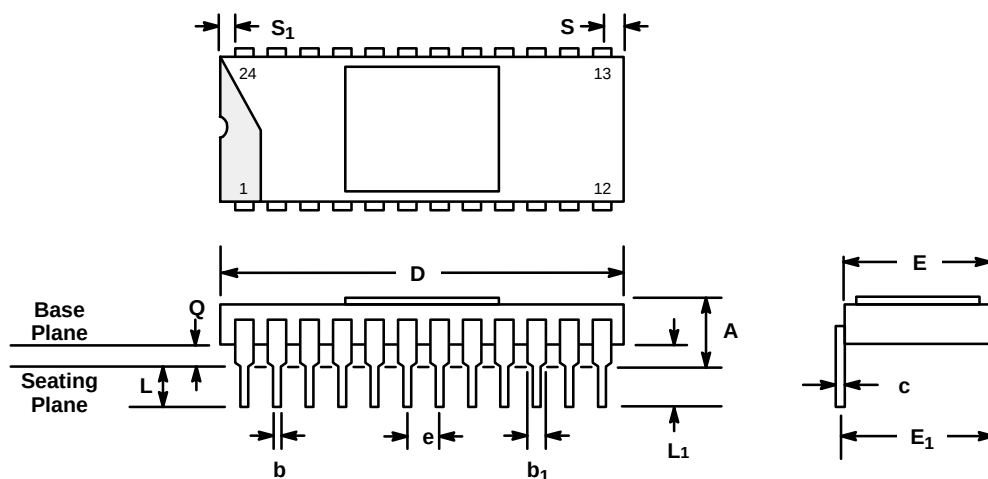


SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	—	0.225	—	5.72	—
b	0.014	0.023	0.356	0.584	—
b ₁	0.038	0.065	0.965	1.65	2
c	0.008	0.015	0.203	0.381	—
D	—	1.290	—	32.77	4
E	0.500	0.610	12.70	15.49	4
E ₁	0.590	0.620	14.99	15.75	7
e	0.100 BSC		2.54 BSC		5
L	0.120	0.200	3.05	5.08	—
L ₁	0.150	—	3.81	—	—
Q	0.015	0.075	0.381	1.91	3
S	—	0.098	—	2.49	6
S ₁	0.005	—	0.13	—	6
α	0°	15°	0°	15°	—

NOTES

1. Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
2. The minimum limit for dimension b₁ may be 0.023 (0.58 mm) for all four corner leads only.
3. Dimension Q shall be measured from the seating plane to the base plane.
4. This dimension allows for off-center lid, meniscus and glass overrun.
5. The basic lead spacing is 0.100 inch (2.54 mm) between centerlines.
6. Applies to all four corners.
7. This is measured to outside of lead, not center.

**24 LEAD CERAMIC SIDE-BRAZED DUAL-IN-LINE
(600 MIL S/B DIP)
C24**

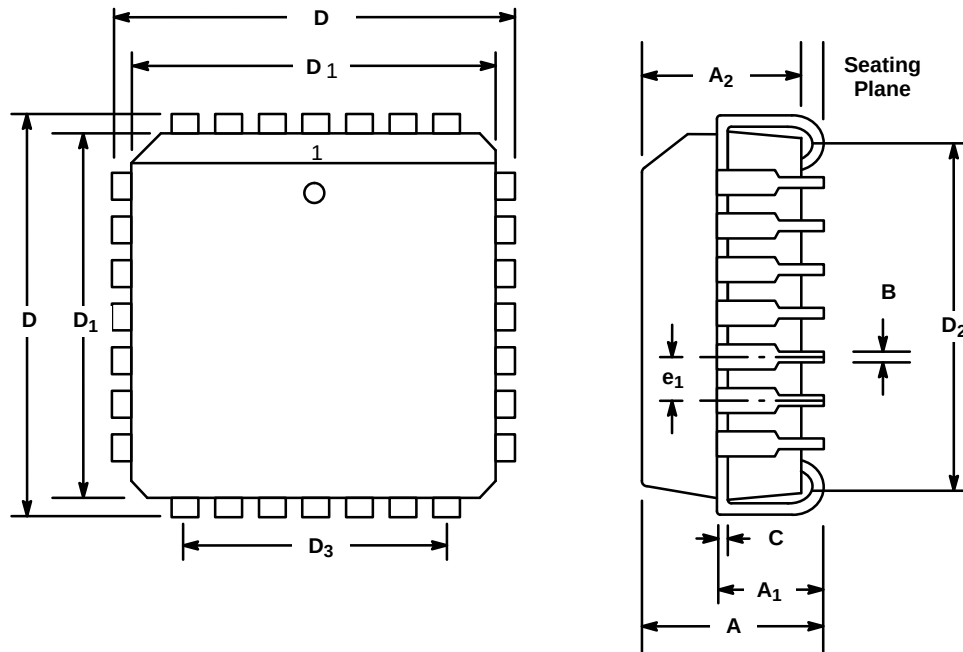


SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	—	0.225	—	5.72	—
b	0.014	0.023	0.356	0.584	—
b ₁	0.038	0.065	0.965	1.65	2
c	0.008	0.015	0.203	0.381	—
D	—	1.290	—	32.77	4
E	0.500	0.610	12.70	15.49	4
E ₁	0.590	0.620	14.99	15.75	7
e	0.100 BSC		2.54 BSC		5
L	0.120	0.200	3.05	5.08	—
L ₁	0.150	—	3.81	—	—
Q	0.015	0.075	0.381	1.91	3
S	—	0.098	—	2.49	6
S ₁	0.005	—	0.13	—	6

NOTES

1. Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
2. The minimum limit for dimension b₁ may be 0.023 (0.58 mm) for all four corner leads only.
3. Dimension Q shall be measured from the seating plane to the base plane.
4. This dimension allows for off-center lid, meniscus and glass overrun.
5. The basic lead spacing is 0.100 inch (2.54 mm) between centerlines.
6. Applies to all four corners.
7. E₁ shall be measured at the centerline of the leads.

**28 LEAD PLASTIC LEADED CHIP CARRIER
(PLCC)
P28**



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.165	0.180	4.19	4.57
A ₁	0.100	0.110	2.54	2.79
A ₂	0.148	0.156	3.76	3.96
B	0.013	0.021	0.330	0.533
C	0.008	0.012	0.203	0.305
D	0.485	0.495	12.32	12.57
D ₁ (1)	0.450	0.454	11.43	11.53
D ₂	0.390	0.430	9.91	10.92
D ₃	0.300 Ref		7.62 Ref.	
e ₁	0.050 BSC		1.27 BSC	

Note: (1) Dimension D₁ does not include mold protrusion.
Allowed mold protrusion is 0.254 mm/0.010 in.

Notes

Notes

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